## Typical Applications

The HMC199AMS8 / 199AMS8E is ideal for:

- Cellular
- ISM Basestations
- PCS

Functional Diagram


## Features

RoHS-Compliant Product
Integrated Dual SPDTs
Low Insertion Loss: <0.5 dB @ 2 GHz
Positive Control: 0/+5V, 0/+3V
Ultra Small MSOP8 Package: 14.8 mm²

## General Description

The HMC199AMS8 \& HMC199AMS8E are low-cost general purpose dual SPDT GaAs "bypass" switches in 8-lead MSOP packages covering DC to 2.5 GHz . These four-RF-port components integrate two SPDT switches and a through line onto a single IC. The designs provide low insertion loss of less than 0.5 dB while switching passive or active external circuit components in and out of the signal path. Port to port isolations are typically 25 to 30 dB . On-chip circuitry enables positive voltage control operation at very low DC currents with control inputs compatible with CMOS and most TTL logic families. Applications include LNA or filter bypass switching and single bit attenuator switching. The HMC199AMS8E is a RoHScompliant product.

Electrical Specifications, $T_{A}=+25^{\circ} \mathrm{C}$, Vctl $=\mathbf{0} / \mathbf{+ 5} \mathrm{Vdc}$, 50 Ohm System

| Parameter | Frequency | Min. | Typ. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Insertion Loss | $\begin{aligned} & \mathrm{DC}-1.0 \mathrm{GHz} \\ & \mathrm{DC}-2.0 \mathrm{GHz} \\ & \mathrm{DC}-2.5 \mathrm{GHz} \end{aligned}$ |  | $\begin{aligned} & \hline 0.3 \\ & 0.4 \\ & 0.6 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline 0.6 \\ & 0.8 \\ & 1.0 \\ & \hline \end{aligned}$ | dB <br> dB <br> dB |
| Isolation (Between Ports RFC1 and RFC2 / RF1 / RF2) | $\begin{aligned} & \mathrm{DC}-2.0 \mathrm{GHz} \\ & \mathrm{DC}-2.5 \mathrm{GHz} \end{aligned}$ | $\begin{aligned} & 22 \\ & 17 \end{aligned}$ | $\begin{aligned} & 25 \\ & 22 \end{aligned}$ |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |
| Return Loss (On State, Any Port) | $\begin{aligned} & \mathrm{DC}-2.0 \mathrm{GHz} \\ & \mathrm{DC}-2.5 \mathrm{GHz} \end{aligned}$ | $\begin{aligned} & 20 \\ & 20 \end{aligned}$ | $\begin{aligned} & 30 \\ & 30 \end{aligned}$ |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |
| Input Power for 1 dB Compression | $0.5-2.0 \mathrm{GHz}$ | 25 | 28 |  | dBm |
| Input Third Order Intercept <br> (Two-tone Input Power $=13 \mathrm{dBm}$ Each Tone) | 0.5-2.0 GHz | 40 | 55 |  | dBm |
| Switching Characteristics <br> tRISE, tFALL (10/90\% RF) <br> tON, tOFF ( $50 \%$ CTL to $10 / 90 \%$ RF) | DC - 2.5 GHz |  | $\begin{aligned} & 20 \\ & 40 \end{aligned}$ |  | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |

Insertion Loss


Isolation Between Ports RFC1 and RFC2 / RF1 / RF2



## 0.1 and 1 dB Compression Point



Return Loss


Isolation Between Ports RF1 and RF2


Note: RFC1 - RFC2 is in insertion loss state

## Input Third Order Intercept Point



## Absolute Maximum Ratings

| RF Input Power $\mathrm{V}_{\mathrm{CTL}}=0 /+5 \mathrm{~V}$ | +29.3 dBm |
| :--- | :--- |
| Control Voltage Range (A \& B) | -0.5 to +7.5 Vdc |
| Channel Temperature | $150^{\circ} \mathrm{C}$ |
| Continuous Pdiss $\left(\mathrm{T}=85^{\circ} \mathrm{C}\right)$ <br> (derate $5.85 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\left.85^{\circ} \mathrm{C}\right)$ | 0.38 W |
| Thermal Resistance | $171^{\circ} \mathrm{C} / \mathrm{W}$ |
| Storage Temperature | -65 to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature | -40 to $+85^{\circ} \mathrm{C}$ |
| ESD Sensitivity (HBM) | Class 1 A |

Distortion vs. Frequency

| Control Input | Input Third Order Intercept (dBm) <br> O dBm Each Tone |  |
| :---: | :---: | :---: |
| $(\mathrm{Vdc})$ | 900 MHz | 1900 MHz |
| +5 | 56 | 52 |
| +3 | 52 | 47 |

## Truth Table

*Control Input Tolerances are $\pm 0.5$ Vdc

| Control Input* |  | Control Current <br> (Typical) |  | Signal Path |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A <br> $(\mathrm{Vdc})$ | B <br> $(\mathrm{Vdc})$ | la <br> $(\mu \mathrm{A})$ | lb <br> $(\mu \mathrm{A})$ | RFC1 <br> to <br> RFC2 | RFC1 <br> to <br> RF1 | RFC2 <br> to <br> RF2 |
| 0 | +5 | -1 | 1 | ON | OFF | OFF |
| +5 | 0 | 1 | -1 | OFF | ON | ON |
| 0 | +3 | -0.1 | 0.1 | ON | OFF | OFF |
| +3 | 0 | 0.1 | -0.1 | OFF | ON | ON |

DC blocking capacitors are required at ports RFC1, RFC2, RF1, RF2. Choose value for lowest frequency of operation.

Compression vs. Frequency

|  | Carrier at 900 MHz |  | Carrier at 1900 MHz |  |
| :---: | :---: | :---: | :---: | :---: |
| CTL <br> Input | Input Power <br> for 0.1 dB <br> Compression | Input Power <br> for 1.0 dB <br> Compression | Input Power for <br> 0.1 dB <br> Compression | Input Power <br> for 1.0 dB <br> Compression |
| (Vdc) | $(\mathrm{dBm})$ | $(\mathrm{dBm})$ | $(\mathrm{dBm})$ | $(\mathrm{dBm})$ |
| +5 | 28 | 30 | 27 | 29 |
| +3 | 20 | 23 | 20 | 22 |

Caution: Do not operate continuously at RF power input greater than 1 dB compression and do not "hot switch" power levels greater than +22 dBm (Control $=0 /+5 \mathrm{Vdc}$ ).

## Outline Drawing



## NOTES:

1. LEADFRAME MATERIAL: COPPER ALLOY
2. DIMENSIONS ARE IN INCHES [MILLIMETERS].
3. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15 mm PER SIDE.
4. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25 mm PER SIDE.
5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

## Package Information

| Part Number | Package Body Material | Lead Finish | MSL Rating | Package Marking ${ }^{[3]}$ |
| :---: | :---: | :---: | :---: | :---: |
| HMC199AMS8 | Low Stress Injection Molded Plastic | Sn/Pb Solder | MSL1 ${ }^{[1]}$ | H199A <br> XXXX |
| HMC199AMS8E | RoHS-compliant Low Stress Injection Molded Plastic | $100 \%$ matte Sn | MSL1 $^{[2]}$ | $\frac{\text { H199A }}{\text { XXXX }}$ |

[1] Max peak reflow temperature of $235^{\circ} \mathrm{C}$
[2] Max peak reflow temperature of $260^{\circ} \mathrm{C}$
[3] 4-Digit lot number XXXX

## Typical Application Circuit



## Notes:

1. Set $\mathrm{A} / \mathrm{B}$ control to $0 /+5 \mathrm{~V}$, $\mathrm{Vdd}=+5 \mathrm{~V}$ and use HCT series logic to provide a TTL driver interface.
2. Control inputs $A / B$ can be driven directly with CMOS logic $(\mathrm{HC})$ with Vdd $=5$ to 7 Volts applied to the CMOS logic gates.
3. DC Blocking capacitors are required for each RF port as shown. Capacitor value determines lowest frequency of operation.
4. Highest RF signal power capability is achieved with Vdd $=+7 \mathrm{~V}$ and $\mathrm{A} / \mathrm{B}$ set to $0 /+7 \mathrm{~V}$.

DUAL SPDT SWITCH DC - 2.5 GHz

## Evaluation PCB



List of Materials for
Evaluation PCB EV1HMC199AMS8 ${ }^{[1]}$

| Item | Description |
| :--- | :--- |
| $\mathrm{J} 1-\mathrm{J} 4$ | PCB Mount SMA RF Connector |
| $\mathrm{J} 5-\mathrm{J} 7$ | DC Pin |
| $\mathrm{C} 1-\mathrm{C} 4$ | Chip Capacitor, 0402 Pkg. Choose value for <br> lowest frequency of operation. <br> 330 pF is provided on PCB. |
| R1-R2 | 100 Ohm Resistor, 0402 Pkg. |
| U1 | HMC199AMS8 / 199AMS8E Bypass Switch |
| PCB [2] | 103234 Evaluation PCB 1.5" x 1.5" |

[1] Reference this number when ordering complete evaluation PCB
[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should be generated with proper RF circuit design techniques. Signal lines at the RF ports should have 50 ohm impedance. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.

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